

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{eJL}	28	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	88	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	SS12H SS13H SS14H	I _F = 1A, T _J = 25°C	- V _F	-	0.50	V
	SS15H SS16H			-	0.75	V
	SS19H SS110H			-	0.80	V
Forward voltage ⁽¹⁾	SS115H			-	0.95	V
Forward voltage	SS12H SS13H SS14H	I _F = 1A, T _J = 100°C		-	0.40	V
	SS15H SS16H			-	0.65	V
	SS19H SS110H			-	0.70	V
	SS115H			-	0.85	V
Reverse current @ rated $V_R^{(2)}$	SS12H SS13H SS14H SS15H SS16H	T」= 25°C	I _R	-	0.2	mA
	SS19H SS110H SS115H			-	0.1	mA
	SS12H SS13H SS14H	T _J = 100°C		-	6	mA
	SS15H SS16H			-	5	mA
	SS19H SS110H SS115H			-	-	mA
	SS12H SS13H SS14H	T _J = 125°C		-	-	mA
	SS15H SS16H			-	-	mA
	SS19H SS110H SS115H			-	2	mA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms



ORDERING INFORMATION ORDERING CODE⁽¹⁾ PACKAGE PACKING SS1xH DO-214AC (SMA) 7,500 / Tape & Reel

Notes:

1. "x" defines voltage from 20V(SS12H) to 150V(SS115H)



INSTANTANEOUS REVERSE CURRENT (mA)

100

10

1

0.1

0.01

0.001

10 20 30 40 50 60

SS12H-SS14H

SS15H-SS115H

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

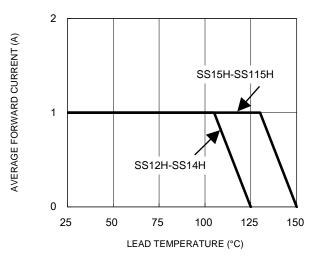


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

TJ=75°C

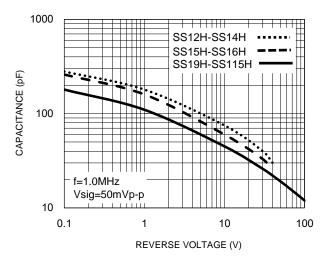
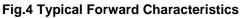


Fig.2 Typical Junction Capacitance



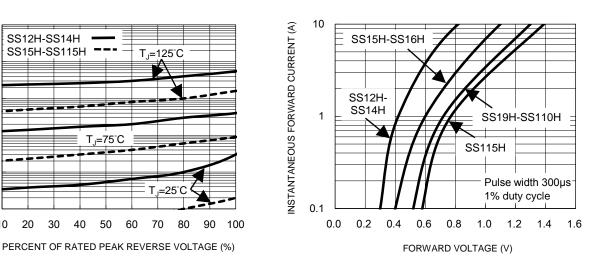
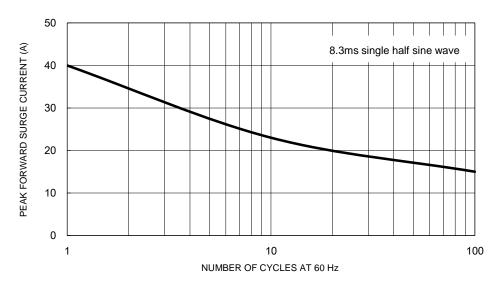


Fig.5 Maximum Non-Repetitive Forward Surge Current





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

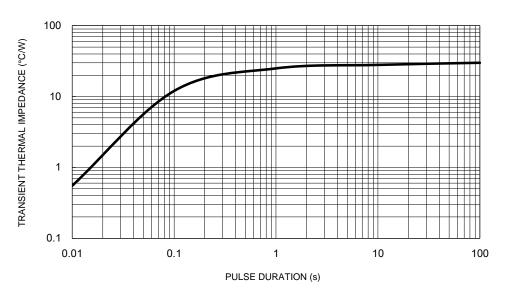


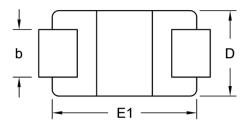
Fig.6 Typical Transient Thermal Characteristics

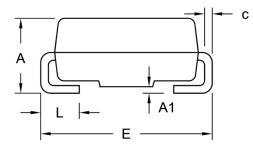


DO-214AC (SMA)

TAIWAN SEMICONDUCTOR

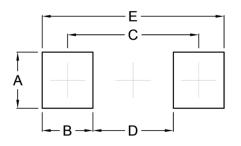
Б





DIM.	Unit (mm)		Unit (inch)	
DIN.	Min.	Max.	Min.	Max.
A	1.99	2.50	0.078	0.098
A1	0.10	0.20	0.004	0.008
b	1.27	1.58	0.050	0.062
с	0.15	0.31	0.006	0.012
D	2.29	2.83	0.090	0.111
E	4.95	5.33	0.195	0.210
E1	4.06	4.60	0.160	0.181
L	0.90	1.41	0.035	0.056

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound
YW	= Date Code

= Factory Code F



Taiwan Semiconductor

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